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(12) **United States Design Patent**
Bdeir

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(54) **CONNECTOR FOR MODULAR ELECTRONIC BUILDING SYSTEM**

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(72) Inventor: **Aya Bdeir**, New York, NY (US)

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(73) Assignee: **littleBits Electronics Inc.**, New York, NV (US)

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(**) Term: **14 Years**

(Continued)

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Primary Examiner — Eric Goodman

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Assistant Examiner — Sanjeev Paul

(51) **LOC (10) Cl.** **13-03**

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(52) **U.S. Cl.**
USPC **D13/146**

(57) **CLAIM**

(58) **Field of Classification Search**
USPC D13/146, 147, 154, 184, 199; D21/398
CPC H01R 9/03; H01R 9/09; H01R 9/091;
H01R 9/096; H01R 9/097; H01R 9/098;
H05K 5/00; H05K 7/00; H05K 11/30; A63H
3/04; A63H 3/006; A63H 3/16
See application file for complete search history.

The ornamental design for a connector for a modular electronic building system, as shown and described.

DESCRIPTION

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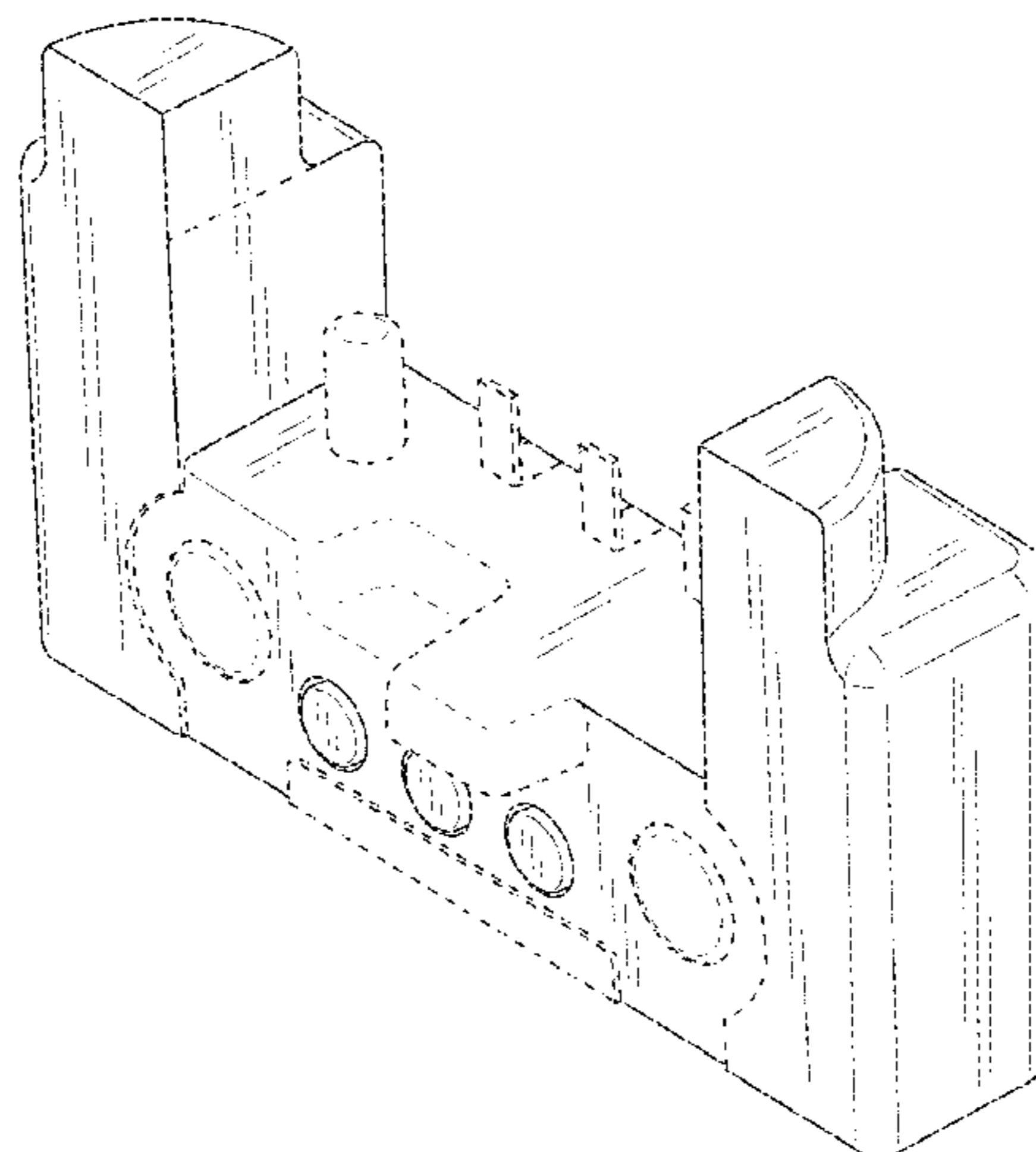
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FIG. 1 is a bottom perspective view of a connector for a modular electronic building system, according to an embodiment;
FIG. 2 is a front view of the connector for a modular electronic building system illustrated in FIG. 1;
FIG. 3 is a rear view of the connector for a modular electronic building system illustrated in FIG. 1;
FIG. 4 is a left side view of the connector for a modular electronic building system illustrated in FIG. 1;
FIG. 5 is a right side view of the connector for a modular electronic building system illustrated in FIG. 1;
FIG. 6 is a bottom view of the connector for a modular electronic building system illustrated in FIG. 1; and,
FIG. 7 is a top view of the connector for a modular electronic building system illustrated in FIG. 1.

The broken lines in the figures show non-claimed portions of the connector for modular electronic building system; the broken lines form no part of the claimed design.

(Continued)

1 Claim, 4 Drawing Sheets



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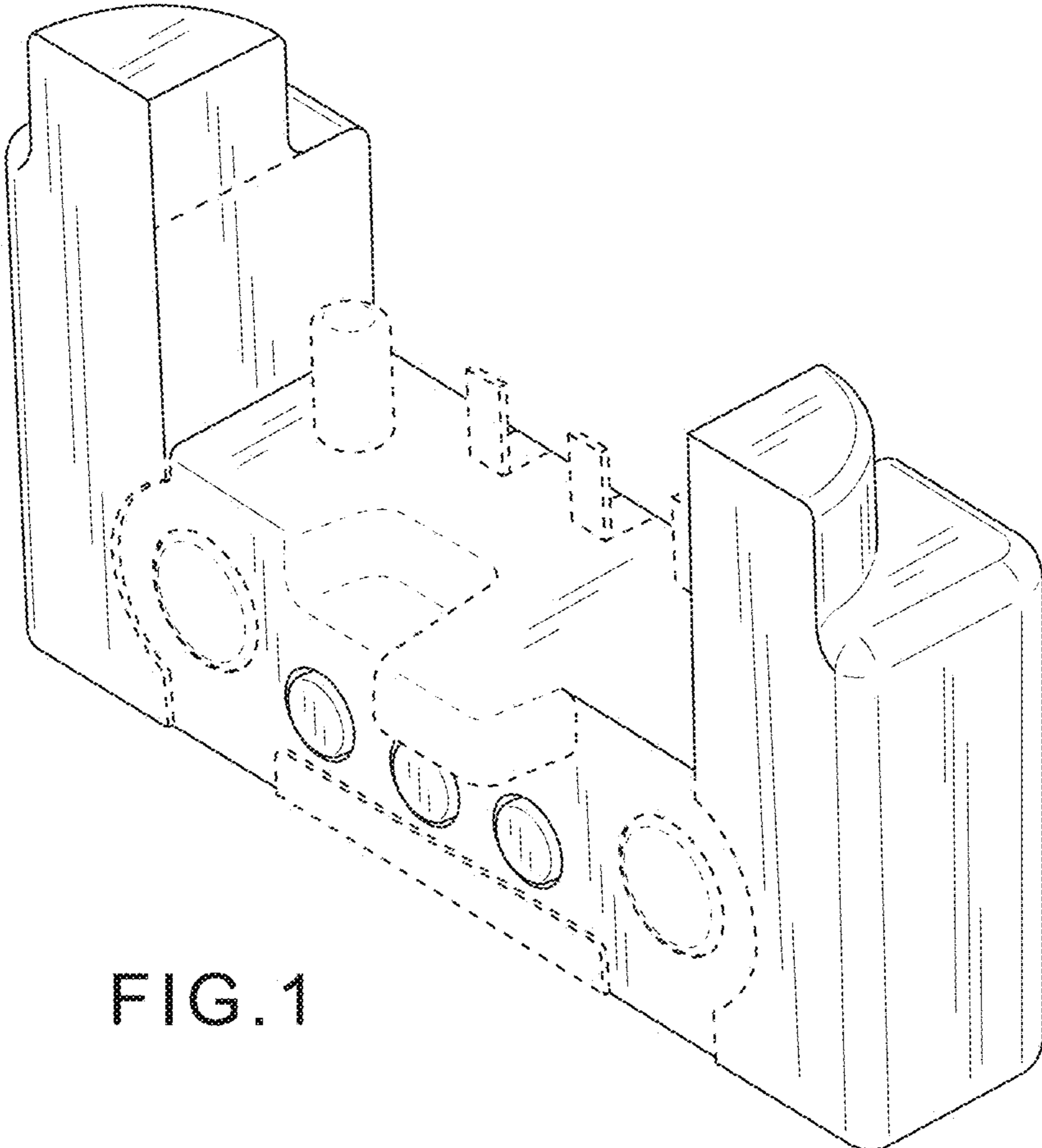


FIG. 1

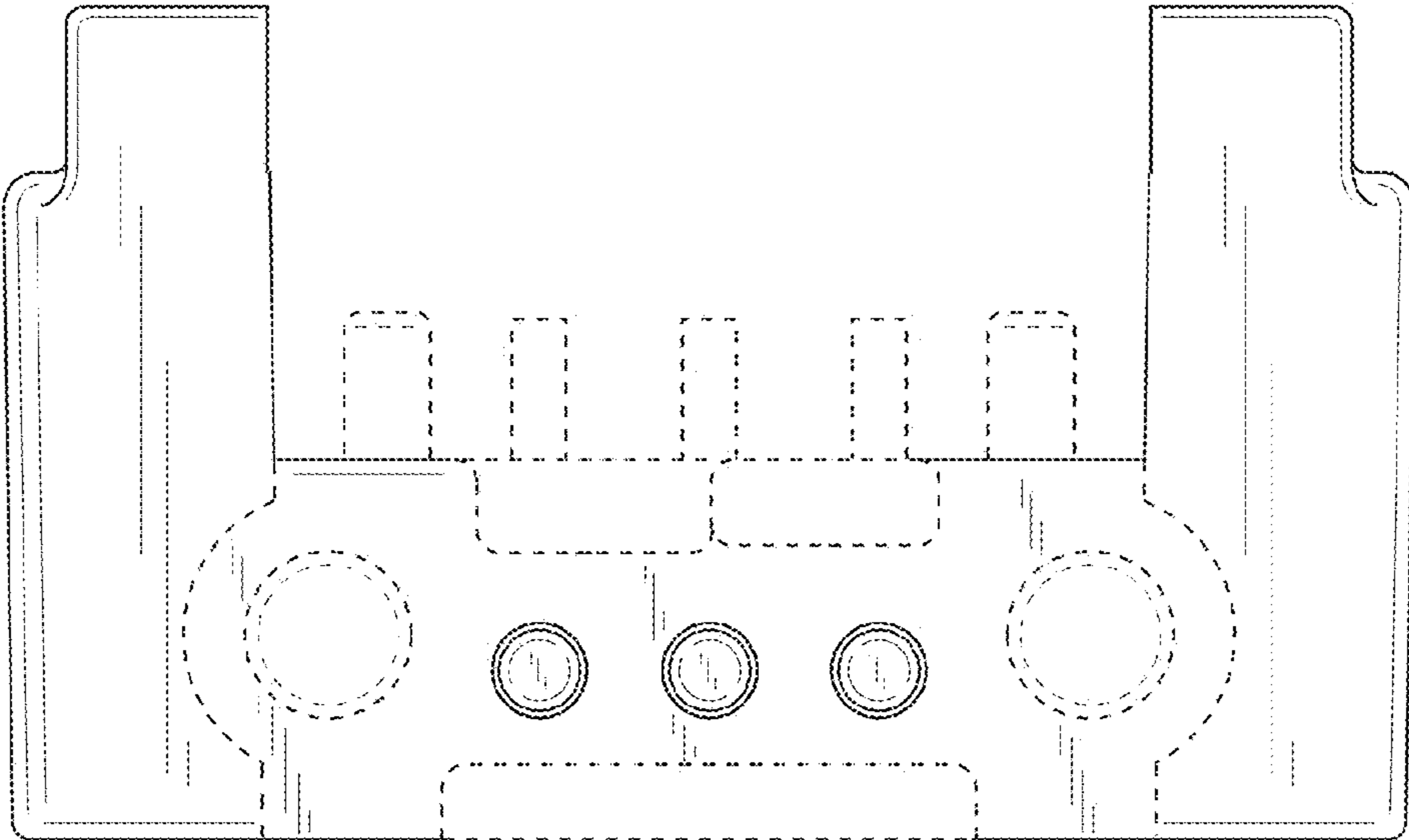


FIG. 2

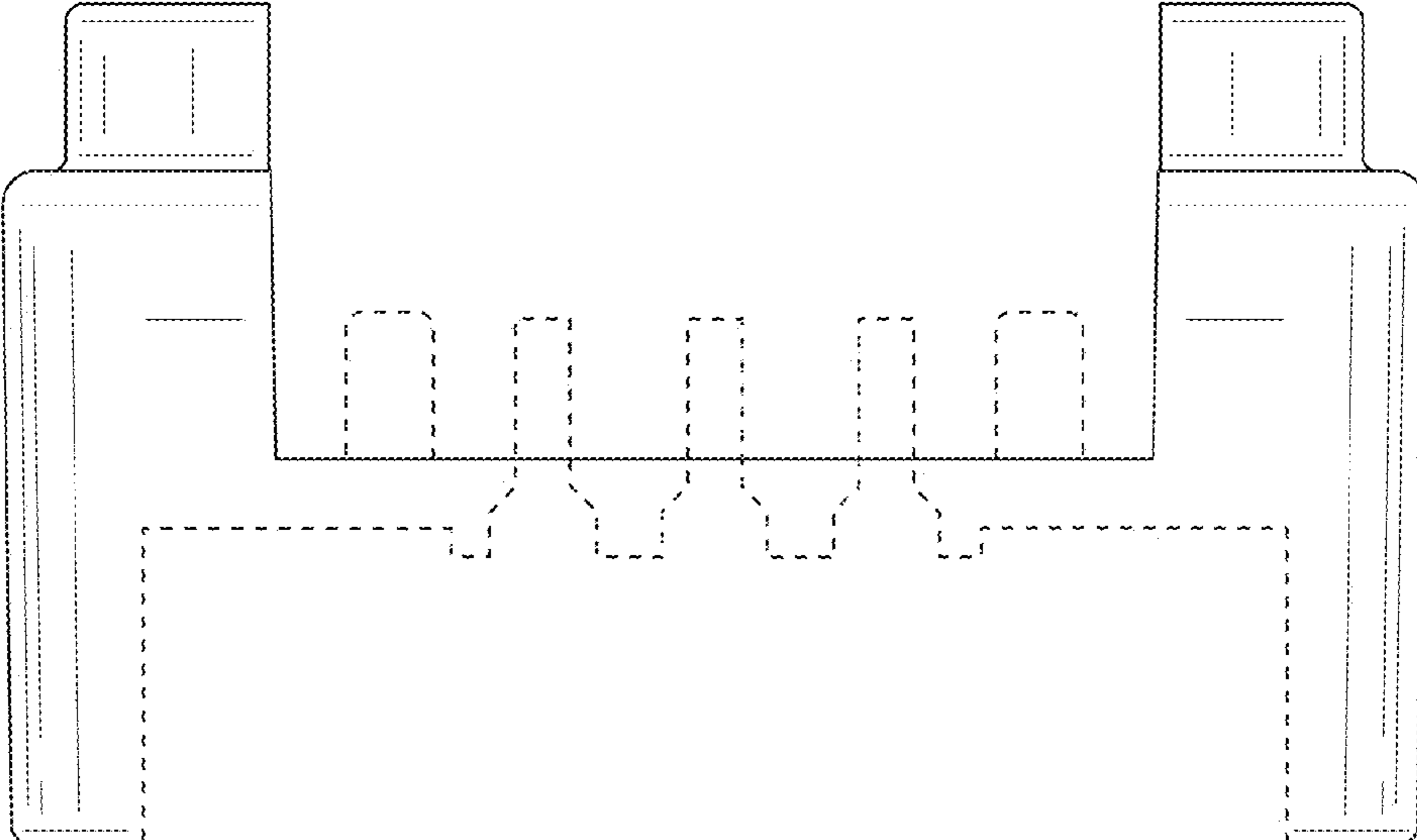


FIG. 3

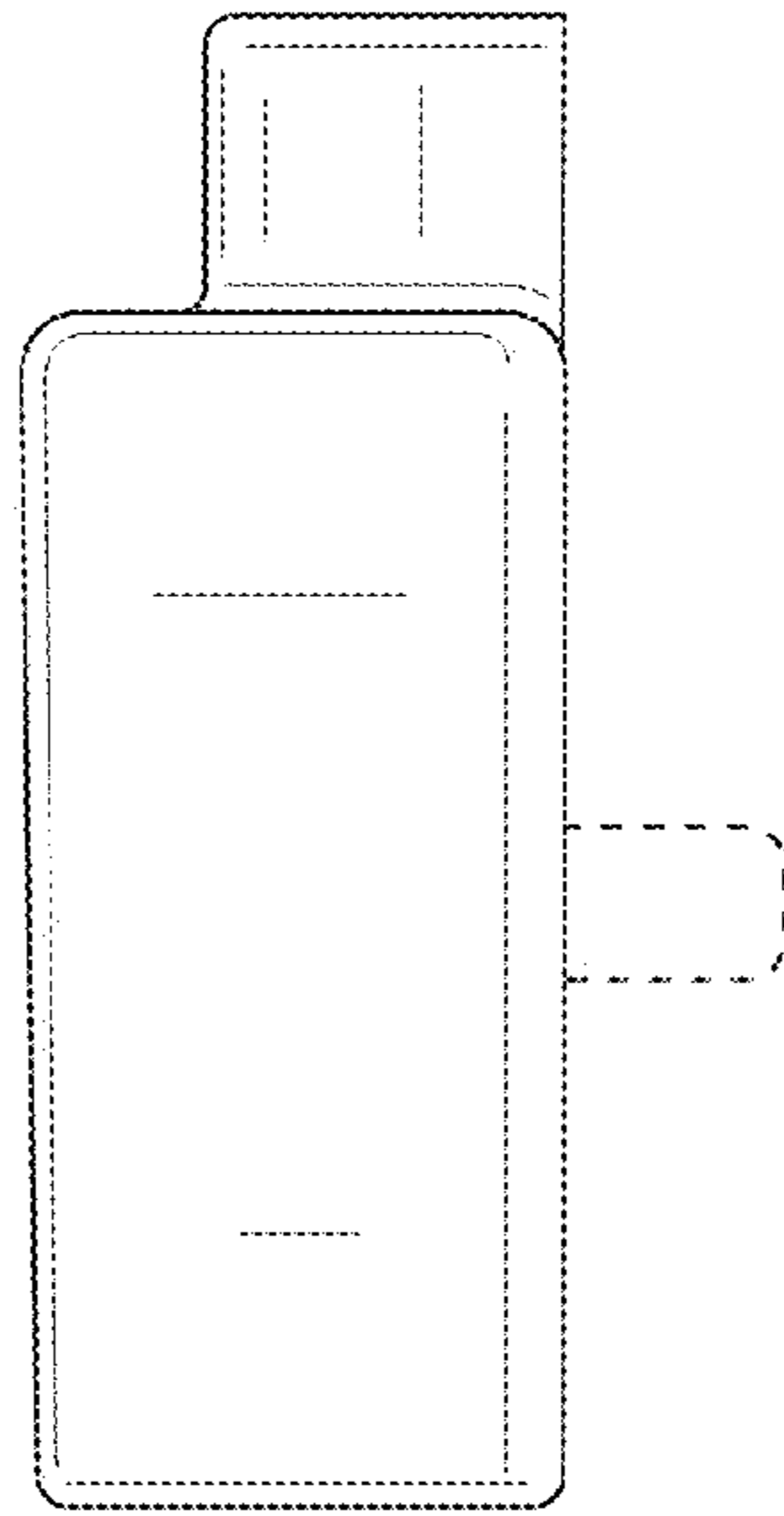


FIG. 4

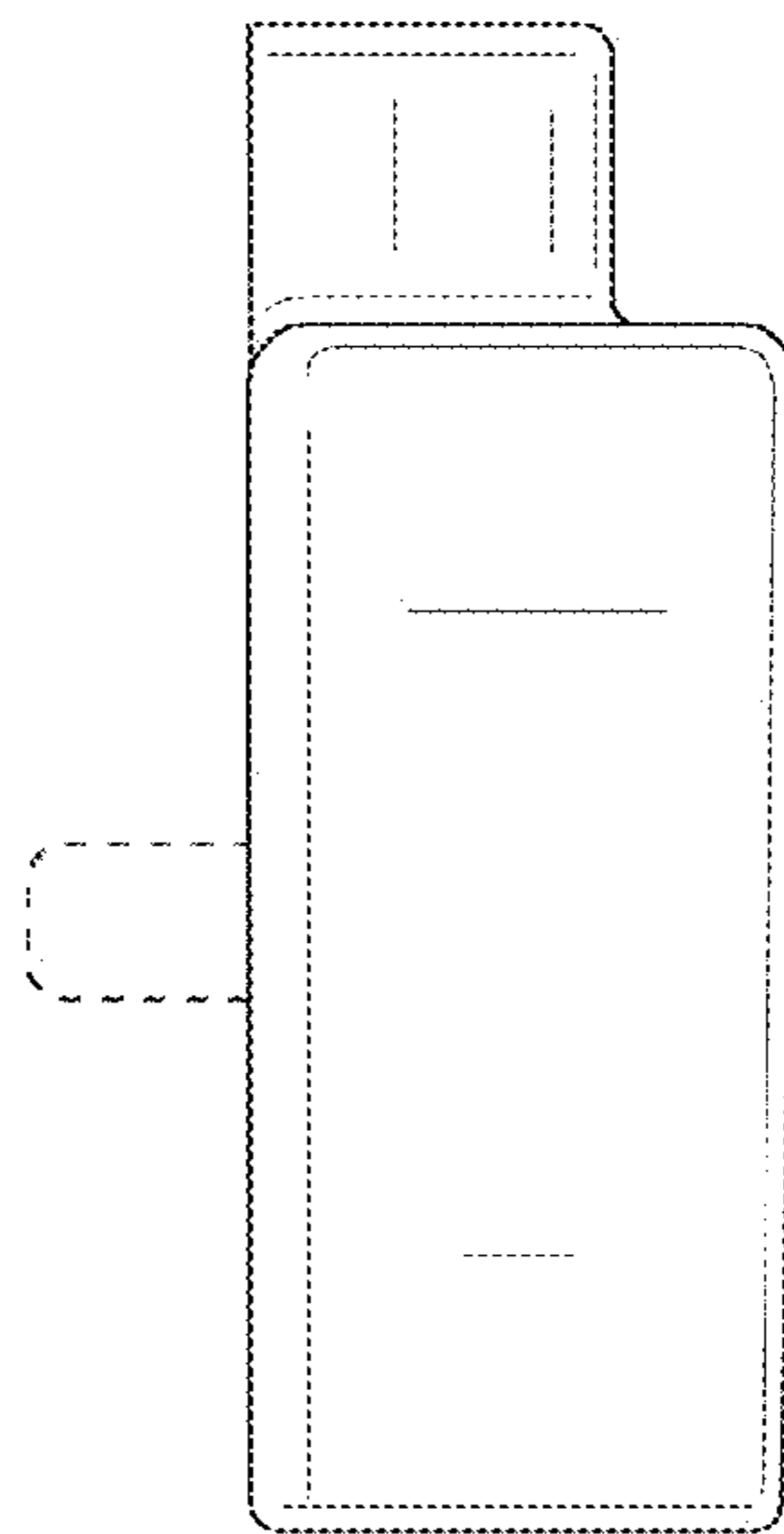


FIG. 5

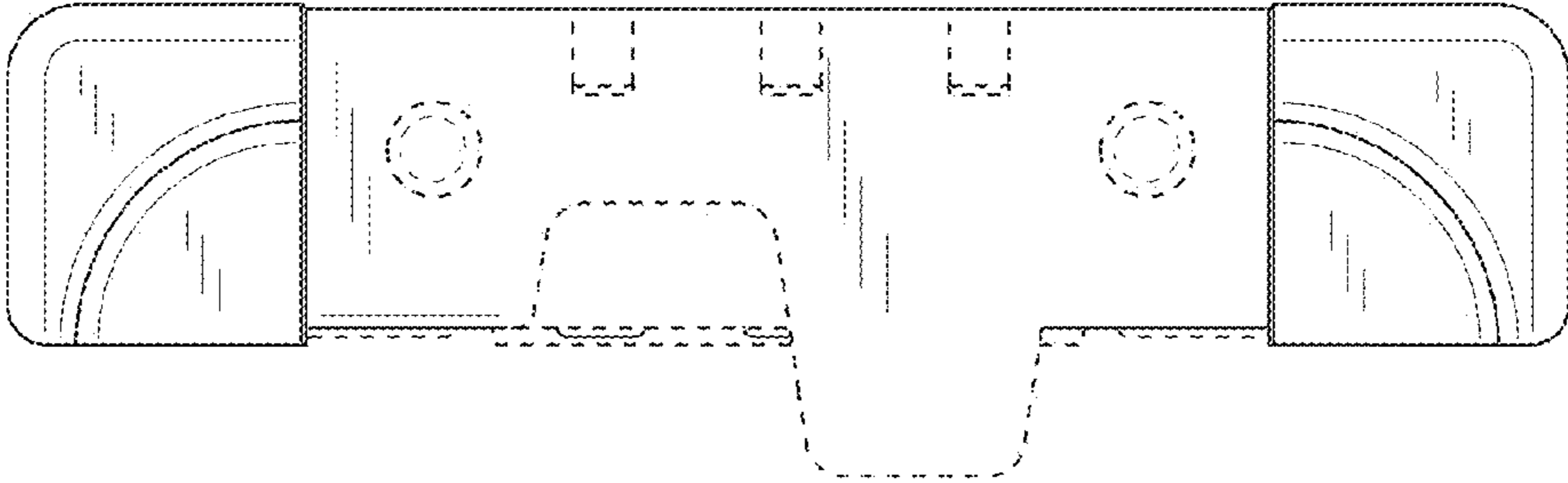


FIG. 6

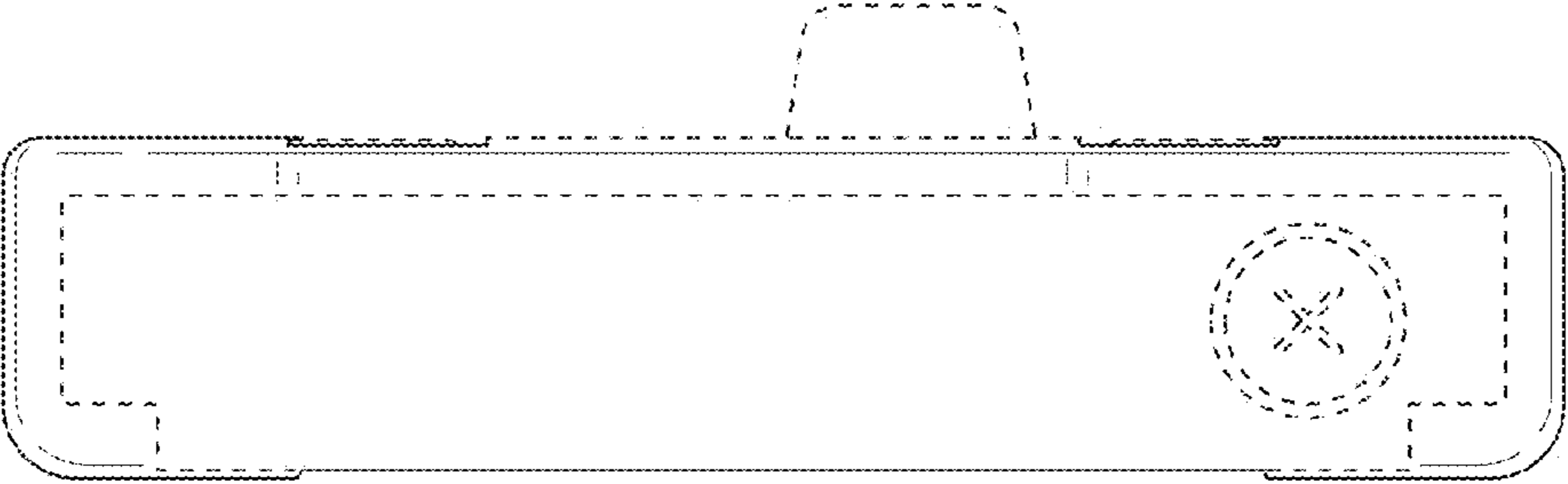


FIG. 7